

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Vishay/Siliconix SI7392ADP-T1-E3

For any questions, you can email us directly: sales@integrated-circuit.com





HALOGEN

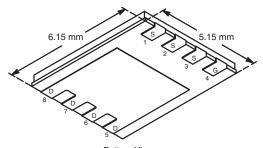
FREE

Vishay Siliconix

N-Channel Reduced Q_g, Fast Switching MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
30	0.0075 at V _{GS} = 10 V	30	12		
	0.0115 at V _{GS} = 4.5 V	30	12		

PowerPAK SO-8



Bottom View

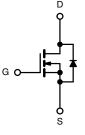
Ordering Information: Si7392ADP-T1-E3 (Lead (Pb)-free) Si7392ADP-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Extremely Low Q_{gd} for Low Switching Losses
- TrenchFET[®] Power MOSFET
- New Low Thermal ResistancePowerPAK[®] Package with Low 1.07 mm Profile
- 100 % R_q Tested
- Complaint to RoHS Directive 2002/95/EC

APPLICATIONS

- High-Side DC/DC Conversion
 - Notebook
 - Server



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T _J = 150 °C) ^a	$T_C = 25 ^{\circ}C$ $T_C = 70 ^{\circ}C$		30 30		
	T _A = 25 °C T _A = 70 °C		17.5 ^{b, c} 14.0 ^{b, c}	А	
Pulsed Drain Current		I _{DM}	50		
Continuous Source-Drain Diode Current	$T_C = 25 ^{\circ}C$ $T_A = 25 ^{\circ}C$	I _S	30 4.5 ^{b, c}	A	
Avalanche Current	L = 0.1 mH	I _{AS}	25		
Single Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	30	mJ	
	T _C = 25 °C		27.5		
Maximum Dawar Dissination	$T_C = 70 ^{\circ}C$	P _D	17.5	W	
Maximum Power Dissipation ^a	$T_A = 25 ^{\circ}C$	٠ ٦	5 ^{b, c}	VV	
	T _A = 70 °C		3.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260	7	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R_{thJA}	20	25	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	3.5	4.5]	

Notes:

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See solder profile (www.vishay.com/ppg?73461). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 70 °C/W.

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Distributor of Vishay/Siliconix: Excellent Integrated System Limited

Datasheet of SI7392ADP-T1-E3 - MOSFET N-CH 30V 30A PPAK SO-8

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Si7392ADP

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		,					
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 1 μA to 250 μA		30		>//00	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 1 μΑ to 250 μΑ		- 6		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0		2.5		
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS} -	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	1		1		
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
Drain-Source On-State Resistance ^a	_	$V_{GS} = 10 \text{ V}, I_D = 12.5 \text{ A}$		0.006	006 0.0075		
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.009	0.0115	Ω	
Forward Transconductance	9 _{fs}	V _{DS} = 15 V, I _D = 12.5 A		46		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1465			
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		360		pF	
Reverse Transfer Capacitance	C _{rss}			150			
Total Gate Charge		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12.5 \text{ A}$		25	38		
				12	18	nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 12.5 \text{ A}$		3.7			
Gate-Drain Charge	Q_{gd}			3.1			
Gate Resistance	R_g	f = 1 MHz		1.9	2.9	Ω	
Turn-On Delay Time	t _{d(on)}			16	25	ns	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_L = 3 \Omega$		50	75		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		21	32		
Fall Time	t _f			8	15		
Turn-On Delay Time	t _{d(on)}			8	15		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_L = 3 \Omega$		35	55		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		23	35		
Fall Time	t _f			8	15		
Drain-Source Body Diode Characteristic	cs						
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			30	^	
Pulse Diode Forward Current ^a	I _{SM}				50	Α	
Body Diode Voltage	V_{SD}	I _S = 2.7 A		0.73	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			26	40	nC	
Body Diode Reverse Recovery Charge	Q_{rr}	L = 10 A dl/dt = 100 A/vs T = 25 °C		19	30		
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		13		ns	
Reverse Recovery Rise Time	t _b			13			

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

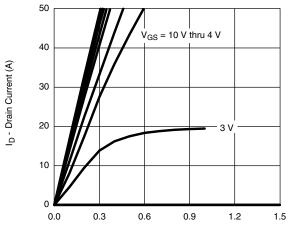
b. Guaranteed by design, not subject to production testing.



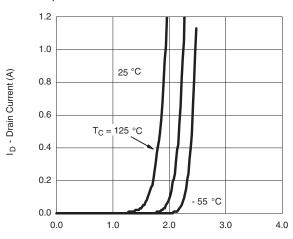


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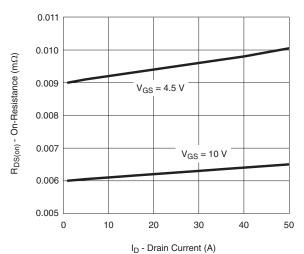
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



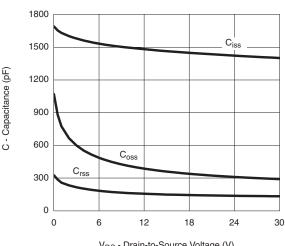
V_{DS} - Drain-to-Source Voltage (V) **Output Characteristics**



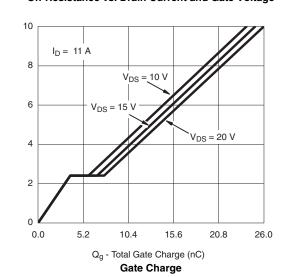
V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**

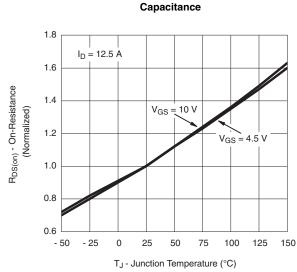


On-Resistance vs. Drain Current and Gate Voltage



V_{DS} - Drain-to-Source Voltage (V)





On-Resistance vs. Junction Temperature

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V_{GS} - Gate-to-Source Voltage (V)

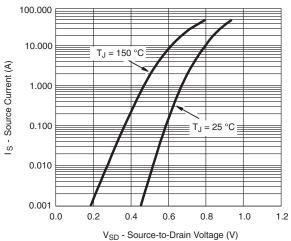
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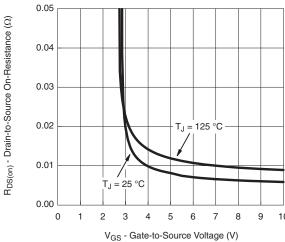
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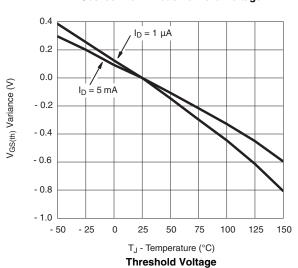
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

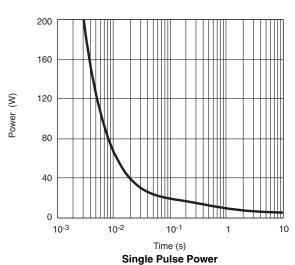


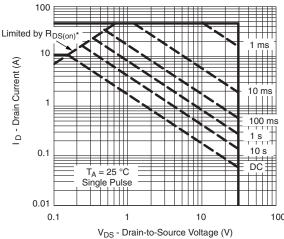
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage







 $\label{eq:VDS} \begin{array}{l} V_{DS} \text{ - Drain-to-Source Voltage (V)} \\ ^*V_{GS} > \text{ minimum } V_{GS} \text{ at which } R_{DS(on)} \text{ is specified} \end{array}$

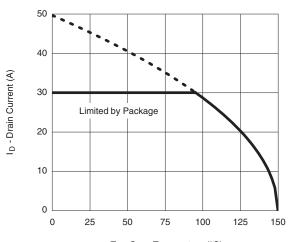
Safe Operating Area, Junction-to-Ambient





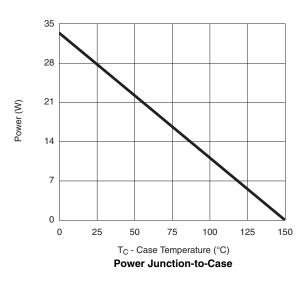
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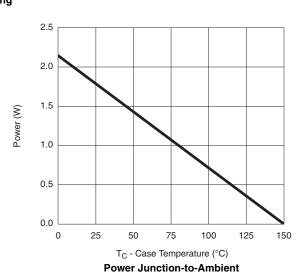
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



T_C - Case Temperature (°C)

Current De-Rating*





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limit.

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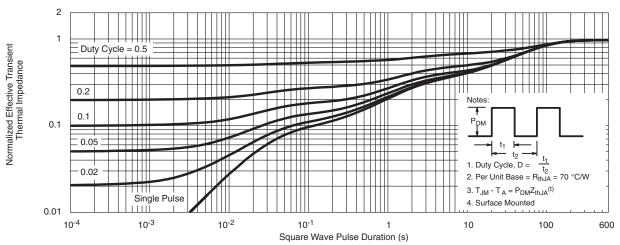
^{*} The power dissipation PD is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package



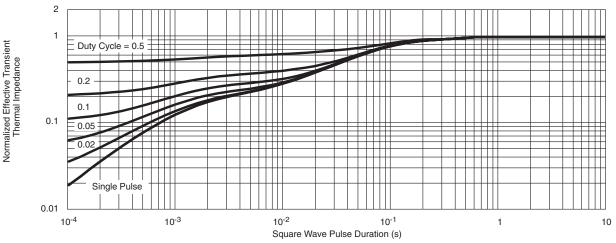
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TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppq?73461.



Distributor of Vishay/Siliconix: Excellent Integrated System Limited

Datasheet of SI7392ADP-T1-E3 - MOSFET N-CH 30V 30A PPAK SO-8

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